

Title (en)

CLIP MODULE FOR POSITIONING A CLIP AT A PREDEFINED ASSEMBLY POSITION OF A CABLE RUN, AND ASSEMBLY HEAD COMPRISING SUCH A CLIP MODULE

Title (de)

CLIPMODUL ZUR POSITIONIERUNG EINES CLIPS AN EINER VORGEGEBENEN MONTAGEPOSITION EINES LEITUNGSSTRANGS SOWIE MONTAGEKOPF MIT EINEM DERARTIGEN CLIPMODUL

Title (fr)

MODULE DE PINCE POUR LE POSITIONNEMENT D'UNE PINCE À UNE POSITION D'ASSEMBLAGE PRÉDÉFINIE D'UN CHEMIN DE CÂBLE ET TÊTE D'ASSEMBLAGE COMPRENANT UN TEL MODULE DE PINCE

Publication

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Application

**EP 20758146 A 20200814**

Priority

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Abstract (en)

[origin: WO2021043561A1] The invention relates to a clip module (10) used for automatically positioning a clip (4) at any angular position on a cable run (6). The clip module (10) comprises a gripper (22) having gripping elements (50) for gripping the clip (4). These gripping elements can be adjusted between an open position and a gripping position by means of a control mechanism. Furthermore, a delivery unit (24) is provided by means of which the gripper (22) can be moved in a longitudinal direction (18) and in a vertical direction (20). The gripper (22) is rotatable and the gripping elements (50) can be actuated in any angular position of the gripper (22).

IPC 8 full level

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